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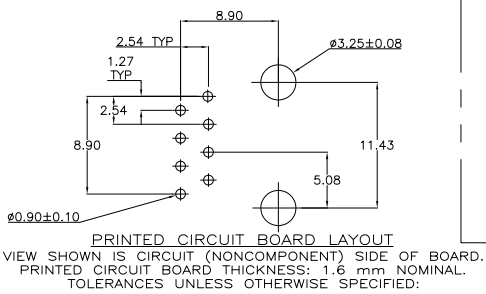
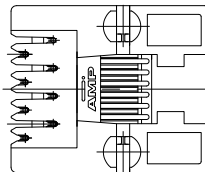
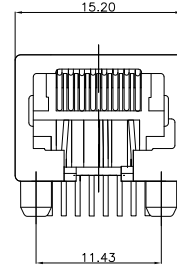
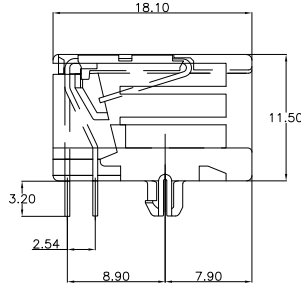
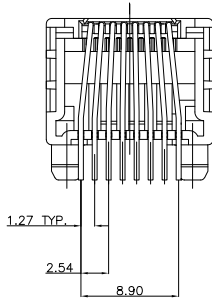
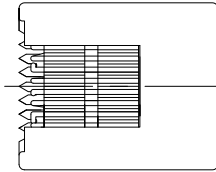
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LOC	DIST	REVISIONS		
F	LR	DESCRIPTION	DATE	BY
L		ECR-10-020218	21JUN2011	PS RRP

NOTES:

1. FOR APPLICATION INFORMATION SEE SPEC. 114-19019.
 2. FOR PERFORMANCE REQUIREMENTS SEE SPEC. 108-19064.
 3. TOLERANCES UNLESS OTHERWISE SPECIFIED: ± 0.15 .
- ⚠** FOR THIS PACKAGING METHOD THE TRUE POSITION OF THE SOLDER TINES IS NOT GUARANTEED.



⚠ 1000 PIECES BULK PACKAGED	8 POS./8 CONTACTS	OVERALL: Ni: 1.27µm MIN. ALL OVER THE CONTACTS SOLDER ZONE: Sn 2.5µm MIN. ON THE SOLDER ZONE OF THE CONTACT MATING ZONE: PLATING CONFIRMS TO PRODUCT REQUIREMENTS AS PER SPECIFICATION 108-19064	HOUSING COLOR BLACK: PBT, UL 94V-0 CONTACT INSERT: PBT, UL 94V-0 CONTACTS: PH BRONZE	2-215878-1 215878-1																						
PACKAGING	REMARKS	FINISH	MATERIAL	ORDER NUMBER																						
THIS DRAWING IS A CONTROLLED DOCUMENT.		<table border="1"> <tr> <td>DESIGNED BY: C.A. STERKEN</td> <td>DATE: 15NOV08</td> <td rowspan="2">TE TE Connectivity</td> </tr> <tr> <td>DRAWN BY: W. BRUMMANS</td> <td>DATE: -</td> </tr> <tr> <td>APPROVED BY: J.V. SOEST</td> <td>DATE: -</td> <td rowspan="2">MODULAR JACK, 8 POS. 90 DEG LOW PROFILE FOR PRINTED CIRCUIT BOARD</td> </tr> <tr> <td>PRODUCT SPEC: 108-19064</td> <td>APPLICATION SPEC: 114-19019</td> </tr> <tr> <td>MATERIAL: SEE NOTES</td> <td>FINISH: SEE NOTES</td> <td>SIZE: A2</td> <td>QAGE CODE: 00779</td> <td>DRAWING NO: C-215878</td> <td>RESTRICTED TO: -</td> </tr> <tr> <td colspan="2">CUSTOMER DRAWING</td> <td>SCALE: -</td> <td>SHEET: 1</td> <td>OF 1</td> <td>REV: L</td> </tr> </table>			DESIGNED BY: C.A. STERKEN	DATE: 15NOV08	TE TE Connectivity	DRAWN BY: W. BRUMMANS	DATE: -	APPROVED BY: J.V. SOEST	DATE: -	MODULAR JACK, 8 POS. 90 DEG LOW PROFILE FOR PRINTED CIRCUIT BOARD	PRODUCT SPEC: 108-19064	APPLICATION SPEC: 114-19019	MATERIAL: SEE NOTES	FINISH: SEE NOTES	SIZE: A2	QAGE CODE: 00779	DRAWING NO: C-215878	RESTRICTED TO: -	CUSTOMER DRAWING		SCALE: -	SHEET: 1	OF 1	REV: L
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